

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Koos et al.

Attorney Docket No.: NOVLP068/NVLS-

2818

Application No.: 10/690,084

Examiner: Vinh, Lan

Filed: October 20, 2003

Group: 1765

Title: METHOD FOR FABRICATION OF SEMICONDUCTOR INTERCONNECT STRUCTURE WITH REDUCED

CAPACITANCE, LEAKAGE CURRENT, AND

IMPROVED BREAKDOWN VOLTAGE

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on May 10, 2006 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

AMENDMENT TRANSMITTAL

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

冈

Transmitted herewith is an Amendment in the above-identified application.

The fee has been calculated as shown below.

	Claims After Amendment		Highest Previously Paid For	Present Extra	Small Entity Rate Fee	Large Entity Rate Fee
Total Claims	75	MINUS	76	0	x 25 =	x 50 = 0.00
Independent Claims	7	MINUS	6	1	x 100 =	x 200 = \$200
Multiple Dependent Claim Present and Fee Not Previously Paid						
				Total	\$	\$200.00

Applicant(s) hereby petition for a _____ month extension(s) of time to respond to the

aforementioned Office Action.

Applicant(s) believe that no (additional) Extension of Time is required; however, if it is determined that such an extension is required, Applicant(s) hereby petition that such an extension be granted and authorize the Commissioner to charge the required fees for an Extension of Time under 37 CFR 1.136 to Deposit Account No. 500388.

X Enclosed is our Check No. 11934 in the amount of \$200.00 to cover the additional claim fee and/or extension of time fees.

 \boxtimes Please charge any additional fees required to facilitate filing the enclosed response, to Deposit Account No. 500388 (Order No. NOVLP068).

Respectfully submitted,

BEYER WEAVER & THOMAS, LLP

Jeffrev K. Weaver Reg. No. 31,314

P.O. Box 70250 Oakland, CA 94612-0250



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Koos et al.

Attorney Docket No.: NOVLP068/NVLS-2818

Application No.: 10/690,084

Examiner: Vinh, Lan

Filed: October 20, 2003

Group: 1765

Title: METHOD FOR FABRICATION OF SEMICONDUCTOR INTERCONNECT STRUCTURE WITH REDUCED

CAPACITANCE, LEAKAGE CURRENT, AND

IMPROVED BREAKDOWN VOLTAGE

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on May 10, 2006 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 223 3-1450.

Signed:

Joyce L. Ferreira

RESPONSE B

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

This is in response to the non-final Office Action mailed February 14, 2006.

Amendments to the Claims are reflected in the listing of claims which begin on page 2 of this papers.

Remarks/Arguments begin on page 10 of this paper.

05/15/2006 ZJUHAR1 00000056 10690084

01 FC:1201

200.00 OP